

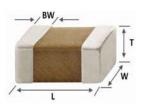


Specification of Automotive MLCC (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL10C470JB81PNC
- Description : CAP, 47pF, 50V, ± 5%, C0G, 0603
- AEC-Q200 Qualified

A. Dimension

Dimension



Size	0603 inch
L	1.60±0.10 mm
W	0.80±0.10 mm
Т	0.80±0.10 mm
BW	0.30±0.20 mm

B. Samsung Part Number

			<u>470</u> @				
0		-					

1 Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0603 (inch code)	L: 1.60±0.10 mm	W: 0.80±0.10 mm
③ Dielectric	C0G	⑧ Inner electrode	Ni
④ Capacitance	47 pF	Termination	Cu
5 Capacitance	± 5%	Plating	Sn 100% (Pb Free)
tolerance		9 Product	Automotive
⑥ Rated Voltage	50 V	Special code	Normal
⑦ Thickness	0.80±0.10 mm	1 Packaging	Cardboard Type, 7" Reel

C. Reliability Test and Judgement condition

Exposure Capacit	ance : No abnorr	ormance nal exterior appearance Within ±2.5% or ±0.25pF	Test condition Unpowered, 1,000hrs @ Max. temperature
Exposure Capacit			
	tance Change :	Within ±2.5% or ±0.25p ^F	
Q :			Measurement at 24±2hrs after test conclusion
Q :		whichever is larger	
	1,000 min.		
IR : Mor	re than 10,000 🕅	Ω or 500 MΩ×μF	
Wh	ichever is smalle	r	
Temperature Cycling Appeara	ance : No abnorr	nal exterior appearance	1,000Cycles
Capacit	tance Change :	Within $\pm 2.5\%$ or $\pm 0.25pF$	Measurement at 24±2hrs after test conclusion
		whichever is larger	
Q :	1,000 min.		1 cycle condition : -55+0/-3 °C (30±3min) → Room Temp. (1min)
IR : Mor	re than 10,000 🕅	Ω or 500 MΩ×μF	→ 125+3/-0 °C (30±3min) → Room Temp. (1min)
Whi	ichever is smalle	r	
Destructive Physical No Defe	ects or abnormal	ities	Per EIA 469
Analysis			
Humidity Bias Appeara	ance : No abnorr	nal exterior appearance	1,000hrs 85℃/85%RH, Rated Voltage and 1.3~1.5V,
Capacit	tance Change :	Within ±2.5% or ±0.25pF	Add 100kohm resistor
		whichever is larger	
Q :	200 min.		The charge/discharge current is less than 50mA.
IR : Mor	re than 500 $^{ m M\Omega}$ or	25 ΜΩ×μF	
Wh	ichever is smalle	r	
High Temperature Appeara	ance : No abnorr	nal exterior appearance	1,000hrs @ 125 °C, 200% Rated Voltage,
Operating Life Capacit	tance Change :	Within ±3% or ±0.3pF	Measurement at 24±2hrs after test conclusion
		whichever is larger	The charge/discharge current is less than 50mA.
Q :	350 min.		
IR : Mor	re than 1,000 MΩ	or 50 MΩ×µF	
Wh	ichever is smalle	r	

	Performance	Test condition				
External Visual	No abnormal exterior appearance	Microscope ('10)				
Physical Dimensions	Within the specified dimensions	Using The calipers				
Mechanical Shock	Appearance : No abnormal exterior appearance	Three shocks in each direction should be applied along				
	Capacitance Change : Within ±2.5% or ±0.25pF	3 mutually perpendicular axes of the test specimen (18 shocks)				
	whichever is larger	Peak value Duration Wave Velocity				
		1,500G 0.5ms Half sine 4.7m/sec				
	Q, IR : Initial spec.					
Vibration	Appearance : No abnormal exterior appearance	5g's for 20min., 12cycles each of 3 orientations,				
	Capacitance Change : Within ±2.5% or ±0.25pF	Use 8"×5" PCB 0.031" Thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted				
	whichever is larger					
		within 2" from any secure point. Test from $10~2,000$ Hz .				
	Q, IR : Initial spec.					
Resistance to	Appearance : No abnormal exterior appearance	Preheating : 150°C for 60~120 sec.				
Solder Heat	Capacitance Change : Within ±2.5% or ±0.25pF	Solder pot∶260±5℃, 10±1sec.				
	whichever is larger					
	Q, IR : Initial spec.					
ESD	Appearance : No abnormal exterior appearance	AEC-Q200-002 or ISO/DIS10605				
	Capacitance Change : Within ±2.5% or ±0.25pF					
	whichever is larger					
	Q, IR : Initial spec.					
Solderability	95% of the terminations is to be soldered	a) Preheat at 155° C for 4 hours, Immerse in solder for 5s at $245\pm5^{\circ}$ C				
	evenly and continuously	b) Steam aging for 8 hours, Immerse in solder for 5s at 245 ± 5 °C				
		c) Steam aging for 8 hours, Immerse in solder for 120s at 260 ± 5 °C solder : a solution ethanol and rosin				
Electrical	Capacitance : Within specified tolerance	The Capacitance / D.F. should be measured at 25°C,				
Characterization	Q : 1,000 min.	$1 \text{ Mz} \pm 10\%$, 0.5~5 Vrms				
onaracterization	IR(25℃): More than 100,000 № or 1,000 №×μF	I.R. should be measured with a DC voltage not exceeding				
	Whichever is smaller.	Rated Voltage @25℃, @125℃ for 60~120 sec.				
	IR(125℃): More than 10,000 № or 100 №×μF					
	Whichever is smaller.					
	Dielectric Strength	Dielectric Strength : 300% of the rated voltage for 1~5 seconds				
Board Flex	Appearance : No abnormal exterior appearance	Bending to the limit, 3 mm for 60 seconds				
	Capacitance Change : Within ±5% or ±0.5pF					
	whichever is larger					
Terminal	Appearance : No abnormal exterior appearance	10 N, for 60 sec.				
Strength(SMD)	Capacitance Change : Within ±2.5% or ±0.25pF					
	whichever is larger					
Beam Load	Destruction value should be exceed 20 N	Beam speed : 0.5±0.05 mm/sec				
Temperature						
Characteristics	From -55 °C to 125 °C, Capacitance change should	be within 0±30ppm/ C				

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260 +0/-5 $^\circ C$, 30sec.), Meet IPC/JEDEC J-STD-020 D Standard

A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- *I* Aerospace/Aviation equipment
- ② Medical equipment
- *③ Military equipment*
- ④ Disaster prevention/crime prevention equipment
- *⑤* Power plant control equipment
- *6* Atomic energy-related equipment
- ⑦ Undersea equipment
- It affic signal equipment
- Data-processing equipment
- Electric heating apparatus, burning equipment
- ⑦ Safety equipment
- 2 Any other applications with the same as or similar complexity or reliability to the applications